



## Material Content Data Sheet



<b>Sales Product Name</b>		BTS5030-1EJA		<b>Issued</b>		5. December 2014		
<b>MA#</b>		MA001064500						
<b>Package</b>		PG-DSO-8-43		<b>Weight*</b>		84.45 mg		
Construction Element	Material Group	Substances	CAS# if applicable	Weight [mg]	Average Mass [%]	Sum [%]	Average Mass [ppm]	Sum [ppm]
chip	inorganic material	silicon	7440-21-3	2.062	2.44	2.44	24418	24418
leadframe	inorganic material	phosphorus	7723-14-0	0.009	0.01		111	
	non noble metal	zinc	7440-66-6	0.038	0.04		445	
	non noble metal	iron	7439-89-6	0.752	0.89		8903	
wire	non noble metal	copper	7440-50-8	30.529	36.15	37.09	361504	370963
	non noble metal	copper	7440-50-8	0.470	0.56	0.56	5562	5562
	encapsulation	organic material	carbon black	1333-86-4	0.097	0.11		1145
plastics	plastics	epoxy resin	-	4.447	5.27		52655	
		inorganic material	silicondioxide	60676-86-0	43.791	51.86	57.24	518542
leadfinish	non noble metal	tin	7440-31-5	0.814	0.96	0.96	9637	9637
plating	noble metal	silver	7440-22-4	0.726	0.86	0.86	8597	8597
glue	plastics	epoxy resin	-	0.125	0.15		1484	
		noble metal	silver	7440-22-4	0.591	0.70	0.85	6997
*deviation	< 10%					Sum in total:	100.00	1000000

### Important Remarks:

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